



OPA358 OPA359 OPA360

SB0S294 - DECEMBER 2003

3V Single-Supply Video Amplifier with Filter in SC70

FEATURES

- EXCELLENT VIDEO PERFORMANCE 0.5dB GAIN FLATNESS: 20MHz DIFF. GAIN: 0.02%, DIFF. PHASE: 0.05°
- DC-COUPLED INPUT
- DC-COUPLED OUTPUT
 - No Output Capacitors Needed(1)
- HIGH SLEW RATE: 70V/us
- INPUT RANGE INCLUDES GROUND
- RAIL-TO-RAIL OUTPUT
- LOW QUIESCENT CURRENT: 5mA
- SINGLE-SUPPLY OPERATING RANGE: 2.7V to 3.3V
- MicroSIZE PACKAGE: SC70-6, SOT23-6
- (1) The final product will have additional circuitry that prevents the output from saturating, even with 0V sync tip level at the input video signal.

SPECIAL FEATURES

- INTERNAL GAIN = 2 (OPA359 and OPA360)
- 2-POLE ANTI-ALIASING FILTER (OPA360 only)
- SAG CORRECTION (OPA359 and OPA360)
 - Reduces Coupling Capacitor Size

APPLICATIONS

- DIGITAL STILL CAMERAS
- CAMERA PHONES
- DIGITAL VIDEO CAMERAS
- SET-TOP-BOX VIDEO FILTERS
- DIGITAL TELEVISIONS

DESCRIPTION

The OPA358, OPA359, and OPA360 high-speed video amplifiers are optimized for 3V single-supply operation. The output swings within 200mV of the positive power-supply rail and 70mV to the negative rail with a typical video load. The input common-mode range includes GND and extends to within 1V of the positive power supply. These devices offer excellent video performance: 0.5dB gain flatness is 20MHz, differential gain is 0.02%, and differential phase is 0.05°. Quiescent current is only 5mA per channel.

The OPA359 and OPA360 have been optimized for space-sensitive applications by integrating internal G=2 setting resistors, a 2-pole Digital-to-Analog converter (DAC) anti-aliasing filter (OPA360 only), and sag correction (OPA359 and OPA360) to reduce the size of the output coupling capacitors. See the Available Options table below. For gains other than 6dB, please contact your local TI sales representative.

In shutdown mode, the quiescent current is reduced to $<5\mu A$, dramatically reducing power consumption. This is especially important in battery-operated equipment such as digital still cameras (DSCs) or digital camcorders.

The OPA358, OPA359, and OPA360 are available in SC70-6 and SOT23-6, the smallest video packages currently available. For higher channel counts, please contact your local TI sales representative.

AVAILABLE OPTIONS

MODEL	CHANNELS(1)	INTERNAL G = 2	SHUTDOWN	FILTER	SAG CORRECTION	SC70-6	SOT23-6
OPA358	1		~			<i>V</i>	~
OPA359	1	~	~		~	ν	~
OPA360	1	~	~	V	~	V	~

⁽¹⁾ Contact factory for other gain configurations and higher channel counts.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.





PRELIMINARY ORDERING INFORMATION(1)

PRODUCT	PACKAGE	PACKAGE DESIGNATOR	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA, QUANTITY
004050	2071 2 201/2 1772 1772		ALIC	OPA358IDCKT	Tape and Reel, 250	
OPA358	SC70-6	DCK	-40°C to +125°C	AUS	OPA358IDCKR	Tape and Reel, 3000
004050	SOT23-6			ALIT	OPA358IDBVT	Tape and Reel, 250
OPA358		DBV	-40°C to +125°C	AUT	OPA358IDBVR	Tape and Reel, 3000
OPA359	SC70-6	DCK	-40°C to +125°C	AUR	OPA359IDCKT	Tape and Reel, 250
					OPA359IDCKR	Tape and Reel, 3000
004050	SOT23-6	TOO 0 DRIV 4000 40500 ALIV		ALIX	OPA359IDBVT	Tape and Reel, 250
OPA359		DBV	-40°C to +125°C	AUX	OPA359IDBVR	Tape and Reel, 3000
0.000	SC70-6	DO14	-40°C to +125°C	AUU	OPA360IDCKT	Tape and Reel, 250
OPA360		DCK			OPA360IDCKR	Tape and Reel, 3000
	00700.0	557	-40°C to +125°C	AUW	OPA360IDBVT	Tape and Reel, 250
OPA360	SOT23-6	DBV			OPA360IDBVR	Tape and Reel, 3000

⁽¹⁾ For the most current package and ordering information, see the Package Option Addendum located at the end of this datasheet.

ABSOLUTE MAXIMUM RATINGS(1)

Supply Voltage, V+ to V
Signal Input Terminals, Voltage ⁽²⁾ $(V-)$ -0.5V to $(V+)$ + 0.5V
Current(2) ±10mA
Output Short-Circuit ⁽³⁾ Continuous
Operating Temperature55°C to +150°C
Storage Temperature65°C to +150°C
Junction Temperature
Lead Temperature (soldering, 10s) +300°C

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.
- (3) Short-circuit to ground, one amplifier per package.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe

proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



ELECTRICAL CHARACTERISTICS: $V_S = +2.7V$ TO +3.3V SINGLE-SUPPLY

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+125^{\circ}C$.

All specifications at $T_A = +25^{\circ}C$, $R_F = 150\Omega$, and connected to $V_S/2$, unless otherwise noted.

PARAMETER			OPA358, OPA359, OPA360			
		CONDITION	MIN	TYP	MAX	UNIT
vs Power Supply	V _{OS} dV _{OS} /dT PSRR	$V_S = +3.3V$ Specified Temperature Range Specified Temperature Range $V_S = +2.7V$ to $+3.3V$		±2 TBD ±80	±9 ± 15 TBD ±350	mV mV μ V/°C μV/V
INPUT BIAS CURRENT Input Bias Current Input Offset Current	I _B I _{OS}			±3 ±1	±50 ±50	pA pA
NOISE Input Voltage Noise Density Input Current Noise Density	e _n i _n	f = 1MHz f = 1MHz		5.8 50		nV/√Hz fA/√Hz
INPUT VOLTAGE RANGE Common-mode Voltage Range Common-mode Rejection Ratio	V _{CM} CMRR	V_S = +3.3V, -0.1V < V_{CM} < 2.3V Specified Temperature Range	(V–) –0.1 66 66	80	(V+) -1	V dB dB
INPUT IMPEDANCE Differential Common-mode				10 ¹³ 1.5 10 ¹³ 1.5		$\Omega \parallel pF$ $\Omega \parallel pF$
OPEN-LOOP GAIN Open-Loop Voltage Gain, OPA358 Over Temperature	A_{OL}	$V_S = +3.3V, 0.07V < V_O < V_S - 0.2V$ $V_S = +3.3V, 0.07V < V_O < V_S - 0.2V$	84 80	92		dB dB
VOLTAGE GAIN OPA359, OPA360		V _S = +3.3V, 0V < V _{IN} < 1.8V		2		V/V
FREQUENCY RESPONSE Small-Signal Bandwidth, OPA358 Gain-Bandwidth Product, OPA358 OPA359 Filter Responses OPA360	f _{-3dB} GBW f _{-3dB}	$G = +1, V_O = 100 \text{mV}_{PP}, R_F = 0\Omega$ $G = +10, R_L = 1 \text{k}\Omega$ $G = +2, V_O = 100 \text{mV}_{PP}, R_F = 560\Omega$		80 70 35		MHz MHz MHz
Filter Response, OPA360 Gain: $f_{in} = 4.5 \text{MHz}$ $f_{in} = 13.5 \text{MHz}$ $f_{in} = 27 \text{MHz}$ Bandwidth for 0.1dB Gain Flatness 0.5dB Gain Flatness Slew Rate Differential Gain Error Differential Phase Error Group Delay (OPA360) Signal-to-Noise Ratio	f _{0.1dB} f _{0.1dB} SR	$G = +2, \ V_O = 2V_{PP}$ $G = +2, \ V_O = 2V_{PP}$ $G = +2, \ V_O = 2V_{PP}$ $G = +2, \ V_O = 100mV_{PP}, \ R_F = 560\Omega$ $G = +2, \ V_O = 100mV_{PP}, \ R_F = 560\Omega$ $V_S = +3.3V, \ G = +2, \ 3V \ Output \ Step$ $NTSC, \ R_L = 150\Omega$ $NTSC, \ R_L = 150\Omega$	TBD	-0.5 -3 -21 15 35 70 0.02 0.05 TBD TBD	TBD	dB dB dB MHz MHz V/µs % o ns dB
Positive Voltage Output Swing from Positive Voltage Output Swing from Positive Output Swing from Rail Negative Output Swing from Rail Voltage Output Swing from Rail Output Current Closed-Loop Output Impedance		$\begin{split} V_S = +3.3 \text{V, } G = 2, \ V_{\text{IN}} = 1.65, \ R_L = 150 \Omega \ \text{to GND} \\ V_S = +3.3 \text{V, } G = 2, \ V_{\text{IN}} = 1.65, \ R_L = 150 \Omega \ \text{to GND} \\ V_S = +3.3 \text{V, } G = 2, \ V_{\text{IN}} = 1.65, \ R_L = 75 \Omega \ \text{to GND} \\ V_S = +3.3 \text{V, } G = 2, \ V_{\text{IN}} = 1.65, \ R_L = 75 \Omega \ \text{to GND} \\ V_S = +3.3 \text{V, } R_L = 1 \text{k} \Omega \\ V_S = +3.3 \text{V} \\ f < 100 \text{kHz} \end{split}$		100 30 TBD TBD 100 ±80 0.02	200 70	mV mV mV mV mV
POWER SUPPLY Specified Voltage Range Minimum Operating Voltage Quiescent Current (per amplifier)	V _S	$V_S = +3.3V$, Enabled, $I_O = 0$ Specified Temperature Range	2.7	2.5 to 3.6 5.2	3.3 6.5 TBD	V V mA mA

⁽¹⁾ Logic low and high levels are CMOS-logic compatible.



ELECTRICAL CHARACTERISTICS: V_S = +2.7V TO +3.3V SINGLE-SUPPLY (continued)

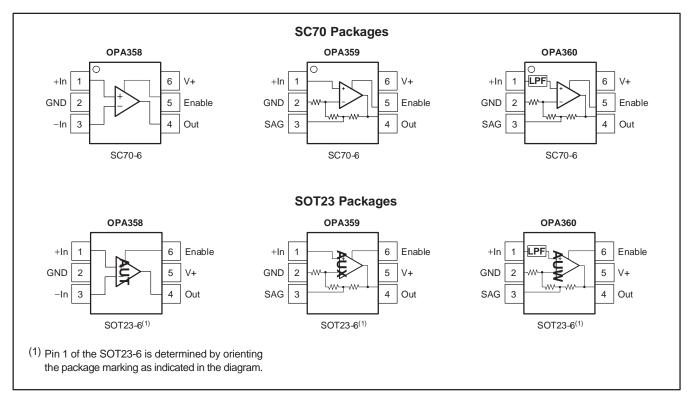
Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+125^{\circ}C$.

All specifications at $T_A = +25$ °C, $R_F = 150\Omega$, and connected to $V_S/2$, unless otherwise noted.

		OPA358, OPA359, OPA360		OPA360	
PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
ENABLE/SHUTDOWN FUNCTION					
Disabled (logic-low threshold) (1)				0.8	V
Enabled (logic-high threshold) (1)		2			V
Enable Time			100		ns
Disable Time			30		ns
Shutdown Current (per amplifier)	$V_S = +3.3V$, Disabled		3.4	5	μΑ
TEMPERATURE RANGE					
Specified Range		-40		+125	°C
Operating Range		-55		+150	°C
Storage Range		-65		+150	°C
Thermal Resistance θ_{JA}					
SC70			250		°C/W
SOT23			200		°C/W

⁽¹⁾ Logic low and high levels are CMOS-logic compatible.

PIN CONFIGURATIONS







12-Dec-2003 www.ti.com

PACKAGING INFORMATION

ORDERABLE DEVICE	STATUS(1)	PACKAGE TYPE	PACKAGE DRAWING	PINS	PACKAGE QTY
OPA358AID	PREVIEW	SOIC	D	8	
OPA358AIDBVR	PREVIEW	SOP	DBV	6	
OPA358AIDBVT	PREVIEW	SOP	DBV	6	
OPA358AIDCKR	PREVIEW	SOP	DCK	6	
OPA358AIDCKT	PREVIEW	SOP	DCK	6	
OPA358AIDR	PREVIEW	SOIC	D	8	
OPA359AIDBVR	PREVIEW	SOP	DBV	6	
OPA359AIDBVT	PREVIEW	SOP	DBV	6	
OPA359AIDCKR	PREVIEW	SOP	DCK	6	
OPA359AIDCKT	PREVIEW	SOP	DCK	6	
OPA360AIDBVR	PREVIEW	SOP	DBV	6	
OPA360AIDBVT	PREVIEW	SOP	DBV	6	
OPA360AIDCKR	PREVIEW	SOP	DCK	6	
OPA360AIDCKT	PREVIEW	SOP	DCK	6	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

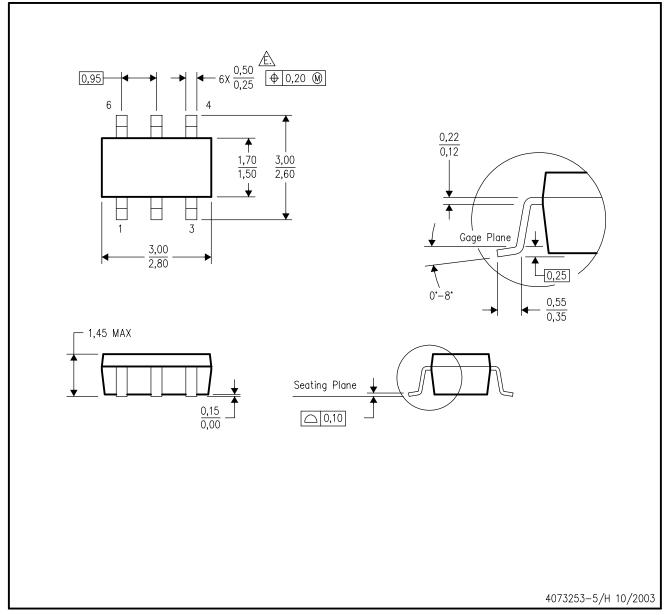
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



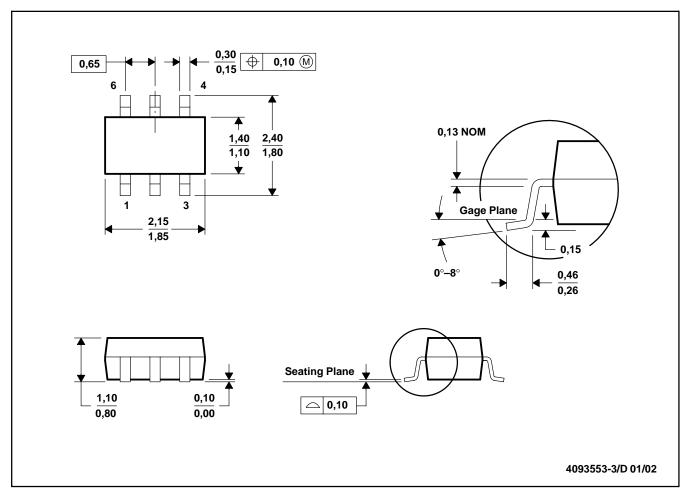
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.



DCK (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



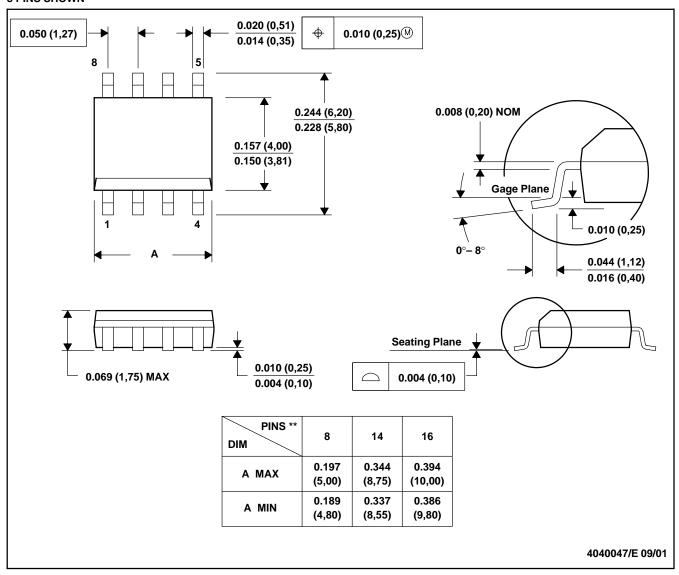
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-203

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2003, Texas Instruments Incorporated